SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N multi-emitter transistor in a TO-39 metal envelope, with the collector connected to the case. The transistor has extremely good intermodulation properties and a high power gain. It is a ruggedized version of the BFW16, which it succeeds. It is primarily intended for:

- Final and driver stages of channel and band aerial amplifiers with high output power for bands I, II, III and IV/V (40–860 MHz).
- Final stage of the wideband vertical amplifier in high speed oscilloscopes.

QUICK REFERENCE DATA

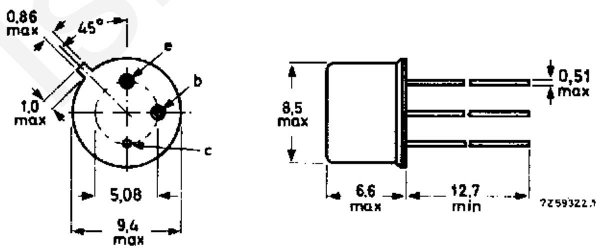
Collector-base voltage (open emitter; peak value)	V_{CBOM}	max.		40	V
Collector-emitter voltage (open base)	V_{CEO}	max.		25	V
Collector current (peak value; f > 1 MHz)	I_{CM}	max.		300	mA
Total power dissipation up to T_{mb} = 125 °C	P_{tot}	max.		1,5	W
Junction temperature	T_j	max.		200	°C
Feedback capacitance at f = 1 MHz I_C = 10 mA; V_{CE} = 15 V	C_{re}	typ.		1,7	pF
Transition frequency I_C = 150 mA; V_{CE} = 15 V; f = 500 MHz	f_T	typ.		1,2	GHz
			f = 200	800	MHz
Power gain (not neutralized) I_C = 70 mA; V_{CE} = 18 V	G_p	typ.	16	6,5	dB
Output power d_{im} = −30 dB; VSWR at output < 2; I_C = 70 mA; V_{CE} = 18 V	P_o	typ.	150	90	mW

MECHANICAL DATA

Dimensions in mm

Collector connected to case

Fig. 1 TO-39.



Maximum lead diameter is guaranteed only for 12,7 mm.

Accessories: 56245 (distance disc).

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter; peak value)	V_{CBOM}	max.	40	V
Collector-emitter voltage ($R_{BE} \leq 50\ \Omega$) peak value	V_{CERM}	max.	40	V [1]
Collector-emitter voltage (open base)	V_{CEO}	max.	25	V [1]
Emitter-base voltage (open collector)	V_{EBO}	max.	2	V

Currents

Collector current (d.c.)	I_C	max.	150	mA
Collector current (peak value; f > 1 MHz)	I_{CM}	max.	300	mA

Power dissipation

Total power dissipation up to T_{mb} = 125 °C	P_{tot}	max.	1.5	W

Temperatures

Storage temperature	T_{stg}		−65 to +200	°C
Junction temperature	T_j	max.	200	°C

THERMAL RESISTANCE

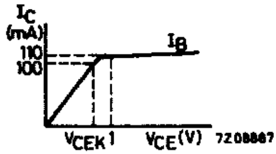
From junction to ambient in free air	$R_{th\ j\text{-}a}$	=	250	°C/W
From junction to mounting base	$R_{th\ j\text{-}mb}$	=	50	°C/W
From mounting base to heatsink mounted with top clamping washer of 56218 and a boron nitride washer for electrical insulation	$R_{th\ mb\text{-}h}$	=	1.2	°C/W

[1] I_C = 10 mA.

CHARACTERISTICS

T_j = 25 °C unless otherwise specified

Collector cut-off current				
I_E = 0; V_{CB} = 20 V; T_j = 150 °C	I_{CBO}	<	20	µA
Knee voltage				
I_C = 100 mA; I_B = value for which I_C = 110 mA at V_{CE} = 1 V	V_{CEK}	<	0.75	V



D.C. current gain				
I_C = 50 mA; V_{CE} = 5 V	h_{FE}	>	25	
I_C = 150 mA; V_{CE} = 5 V	h_{FE}	>	25	
Transition frequency				
I_C = 150 mA; V_{CE} = 15 V; f = 500 MHz	f_T	typ.	1.2	GHz
Collector capacitance at f = 1 MHz				
I_E = I_e = 0; V_{CB} = 15 V	C_c	<	4	pF
Feedback capacitance at f = 1 MHz				
I_C = 10 mA; V_{CE} = 15 V; T_{amb} = 25 °C	C_{re}	typ.	1.7	pF
Noise figure at f = 200 MHz				
I_C = 30 mA; V_{CE} = 15 V; R_S = 75 Ω; T_{amb} = 25 °C	F	<	6	dB

Power gain (not neutralized)

		f = 200	800	MHz
I_C = 70 mA; V_{CE} = 18 V; T_{amb} = 25 °C	G_p	typ. 16	6.5	dB

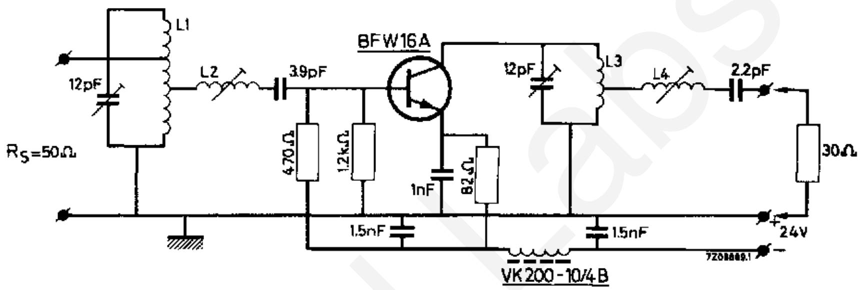
CHARACTERISTICS (continued)

Intermodulation characteristics

1. Output power at f = 200 MHz; T_{amb} = 25 °C

I_C = 70 mA; V_{CE} = 18 V; V.S.W.R. at output < 2
f_p = 202 MHz; f_q = 205 MHz; d_{im} = −30 dB
measured at $f_{(2q-p)}$ = 208 MHz (Channel 9) — P_o > 130 mW; typ. 150 mW

Test circuit:



Coil data:

L1 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 2.7 mm; int. diam. 8 mm; taps at 0.5 turn and 1.5 turns from earth.
L2 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm; int. diam. 8 mm.
L3 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 3.3 mm; int. diam. 8 mm.
L4 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm; int. diam. 11 mm.

CHARACTERISTICS (continued)

Basis of adjustment

The intermodulation at an intermodulation distortion of −30 dB is caused by h.f. output current - voltage clipping.
The maximum undistorted output power is realised, if

a. Current and voltage clipping take place concurrently.
This occurs if

$$R_L = \frac{V_{CE} - V_{CEK}}{I_C},$$

in which V_{CEK} is the high frequency knee voltage.

b. The h.f. collector current is as small as possible.
This is so if $-C_L = +C_{oe}$,
in which C_{oe} is the output capacitance of the transistor at short circuited input.

For maximum output power at an intermodulation distortion of −30 dB, the (experimentally found) values of R_L and C_L are:
$R_L = 220\ \Omega$; $C_L = -5.6$ pF.

C_{oe} is found by 4 pF of the transistor and 1.6 pF by the mounting system concerning of a borium nitride washer between the envelope of the transistor and the chassis.
See also page 10, note 1.

Adjustment procedure

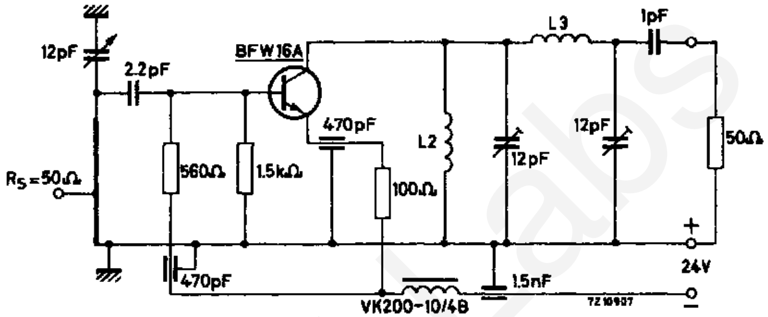
1. Remove the transistor and connect a dummy consisting of a 220 Ω resistor in parallel with a 5.6 pF capacitor between the collector and emitter connections of the output circuit.
2. Tune and match the output circuit for zero reflection at 205 MHz (V.S.W.R. = 1). After this adjustment, no further change may be made in the output circuit.
3. Replace the dummy by the transistor. Tune and match the input circuit for maximum power gain and good band pass curve.
The V.S.W.R. of the output will then, in most cases, be ≤ 2 over the whole channel.
Corrections can be made by tuning L2; this will not disturb the band pass curve.

CHARACTERISTICS (continued)

Intermodulation characteristics

2. Output power at f = 800 MHz; T_{amb} = 25 °C
   I_C = 70 mA; V_{CE} = 18 V; V.S.W.R. at output < 2
   f_p = 798 MHz; f_q = 802 MHz; d_{im} = −30 dB
   measured at $f_{(2q-p)}$ = 806 MHz (Channel 62) P_o > 70 mW, typ. 90 mW

   Test circuit:



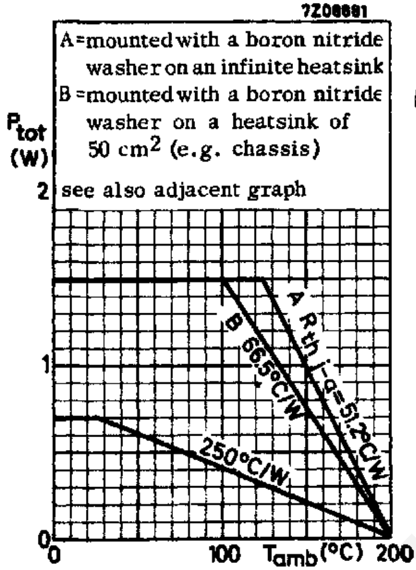
Coil data:
L1 = 25 mm x 7 mm x 0.85 mm silver plated Cu strip
Tap of the input at 5 mm from earth.
L2 = 13 turns enamelled Cu wire (0.6 mm); int. diam. 8 mm
L3 = 1.5 turns Cu wire (1.3 mm); int. diam. 8 mm

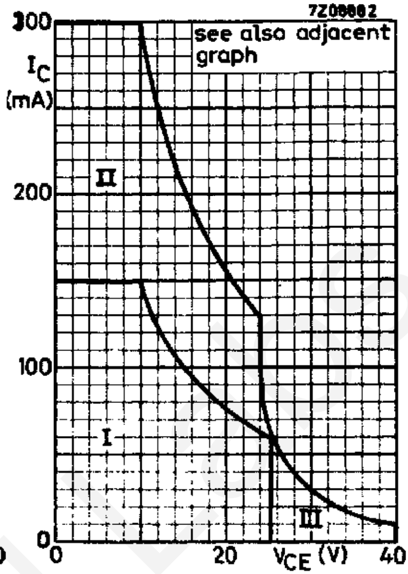
Basis of adjustment

At 800 MHz no dummy can be used to adjust for optimum collector load because at these frequencies the impedance transformations of a dummy are too high. A small signal at the mid-channel frequency of 802 MHz is fed to the input and increased until clipping occurs; that is, until the output power no longer increases linearily with the input signal. This clipping can be eliminated by tuning the output circuit, thereby making the output power equal to

$$P_o = \frac{I_C(V_{CE} - V_{CEK})}{2} = 480 \text{ mW}.$$

The output circuit is adjusted for minimum intermodulation if the input signal is as small as possible at P_o = 480 mW.
With this adjusting method care must be taken, that the transistor is not destructed by second breakdown (the voltage swing may not exceed the rated V_{CER} value). Therefore as soon as clipping occurs, the increase of the input signal should be stopped until the clipping has been eliminated. After this adjustment has been made no further change may be made in the output circuit.
Adjust the input circuit for maximum power gain and good band pass curve. The V.S.W.R. of the output is then ≤ 2 over the whole channel.

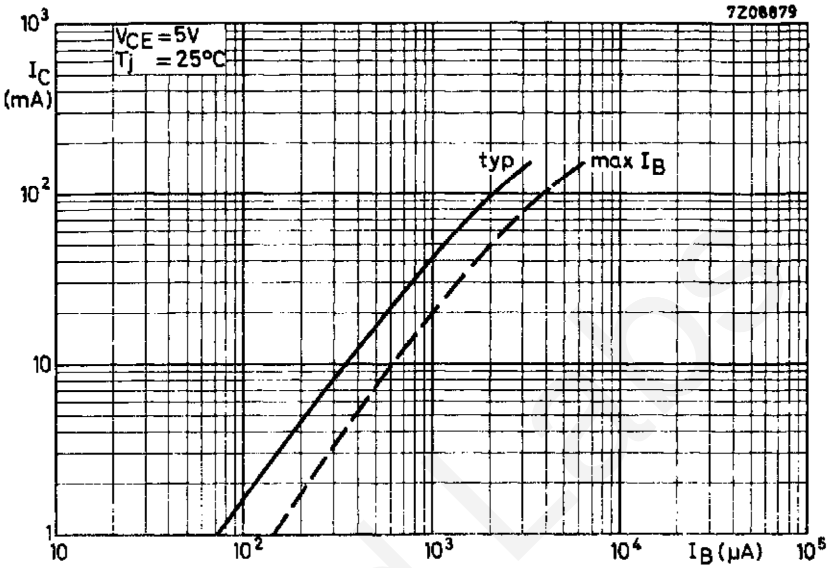


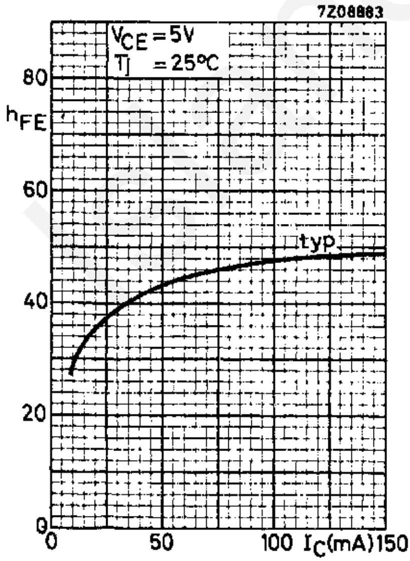


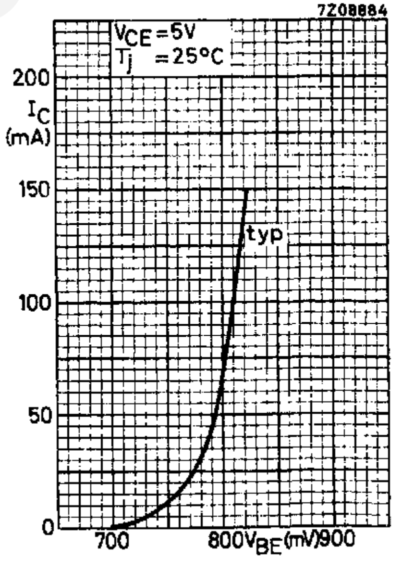
I = Region of permissible operation under all base-emitter conditions and at all frequencies, including d.c.

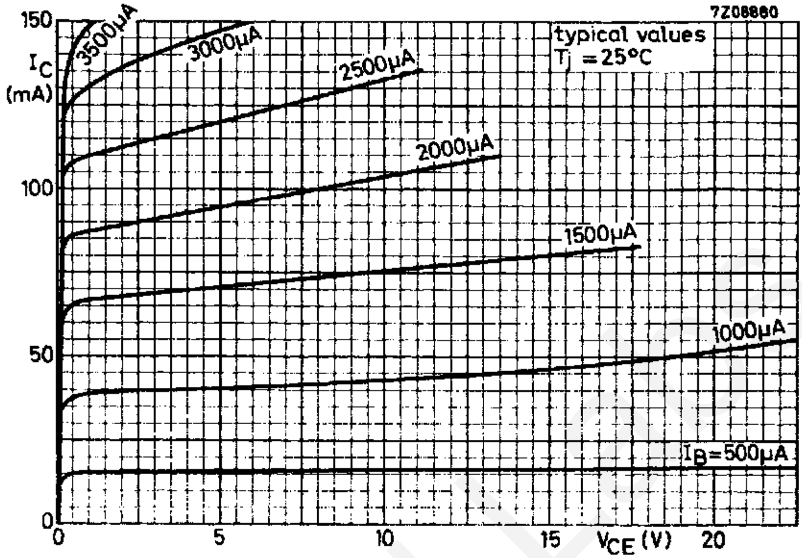
II = Additional region of operation at $f \geq 1$ MHz.

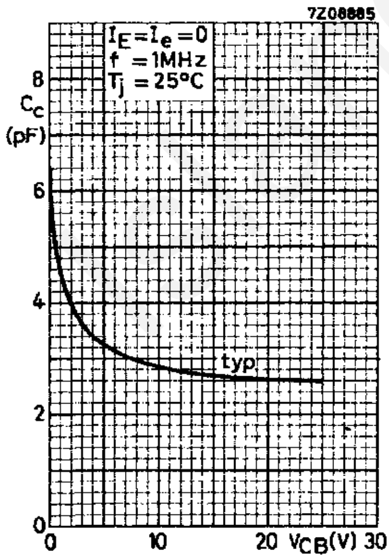
III = Operating under pulsed conditions is allowed, provided the transistor is cut-off with $R_{BE} \leq 50\ \Omega$ and $f \geq 1$ MHz.

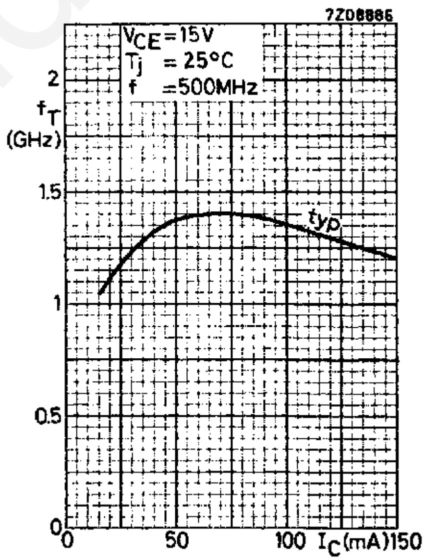

7Z08879
V_{CE} = 5V
Tj = 25°C
I_C (mA)
typ
max I_B
I_B (μA)
10
10^2
10^3
10^4
10^5
1
10
10^2
10^3


7Z08883
V_{CE} = 5V
Tj = 25°C
h_{FE}
typ
0
20
40
60
80
0
50
100
I_C (mA) 150


7Z08884
V_{CE} = 5V
Tj = 25°C
I_C (mA)
typ
0
50
100
150
200
700
800
V_{BE} (mV) 900


7Z08880
typical values
T_j = 25°C
I_C (mA)
V_{CE} (V)
3500µA
3000µA
2500µA
2000µA
1500µA
1000µA
I_B=500µA


7Z08885
$I_E = I_e = 0$
f = 1MHz
T_j = 25°C
C_c (pF)
V_{CB}(V)
typ


7Z08886
V_{CE} = 15V
T_j = 25°C
f = 500MHz
f_T (GHz)
I_C (mA)
typ

APPLICATION INFORMATION

Performance of channel- and band amplifiers [1])

Frequency range	channel 4 61-68	channel 9 202-209	channel 55 742-750	band I 47-68	band II 87.5-108	band III 174-230	MHz
Transistor used in							
final stage	BFW16A	BFW16A	BFW16A	BFW16A	BFW16A	BFW16A	
driver stage		BFW16A	BFW16A			BFW16A	
second stage			BFY90				
first stage	BFY90	BFY90	BFY90	BFY90	BFY90	BFY90	
Output power at							
d_{im} = −30 dB	150 [2])	150 [2])	100				mW
d_{im} = −50 dB					30		mW
d_{im} = −60 dB				10		10	mW
Power gain	50	44	26.5	51	43	39	dB
Noise figure	7	6	8	6.0-6.5	6.5	6.5	dB
V.S.W.R. over the whole channel or band							
for the input	< 2	< 2	< 2	< 2	< 2	< 2	
for the output	< 2	< 2	< 2	< 2	< 2	< 2	
Load impedance	30	30	50	30	30	30	Ω
Source impedance	60	60	50	60	60	60	Ω

[1]) Application information bulletins of all these amplifiers and a study of intermodulation are available on request.

[2]) V_o = 2.2 V over R_L = 30 Ω or
V_o = 3 V over R_L = 60 Ω.